

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	790842	hitachi.as.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2007/02/02 12:45
S2	1404	(multilayer or multi-layer or multi adj layer) and wiring adj board and inorganic	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 10:05
S3	104	wet adj etching and S2	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 08:51
S4	9	warpage and S3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 08:51
S5	157	(multilayer or multi-layer or multi adj layer) and wiring adj board and inorganic	EPO; JPO	OR	ON	2004/11/22 11:48
S6	2	("6709988").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/23 13:06
S7	5	("4358479" "5429709" "6468439" "6533950" "6596184").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/22 11:49
S8	1	("5429709").URPN.	USPAT	OR	ON	2004/11/22 11:53
S9	1030	novolak same dry	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 13:29
S10	2	novolak near dry	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:13
S11	1369	dai adj nippon adj printing	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:57

EAST Search History

S12	18851	dry adj film	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:13
S13	69	S11 and S12	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:13
S14	177	dai adj nippon adj printing and steel	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:23
S15	54	irradiation and S14	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:54
S16	177	dai adj nippon adj printing and steel	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:54
S17	36	irradiation and S16 and dry	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 14:54
S18	25	dai adj nippon adj printing and circuit adj board	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 15:00
S19	511	dai adj nippon adj printing and head	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 15:00
S20	15	dry adj film and S19	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/11/22 15:03
S21	2	("6709988").PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/11/23 13:06

EAST Search History

S22	5	("4358479" "5429709" "6468439" "6533950" "6596184").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2004/11/23 13:07
S23	2504	dry adj film adj resist	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:05
S24	240419	printed adj circuit adj board	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:05
S25	698	S23 and S24	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:05
S26	299581	irradiation	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:06
S27	107	S25 and S26	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:06
S28	381571	ultraviolet or ultra adj violet	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:06
S29	69	S27 and S28	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 16:04
S30	16784	wet adj etch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:07

EAST Search History

S31	0	S29 and S30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 15:07
S32	287466	etch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 16:04
S33	13	S29 and S32	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/11/16 16:04
S34	3746	(438/106).CCLS.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2007/02/02 12:46